LINEAR AMPLIFIERS FOR MOBI **Application Note**

intended mainly for amateur radio application

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Prepared By:

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INEAR AMPLIFIERS

RF Circuits Engineering

Linear broadband amplifiers for 1.6 to

30 MHz are described in this application note. One circuit board layout with modified component values is employed at three specified power levels with Motorola MRF453, MRF454 and MRF421 devices. All designs feature a nominal 13.6 V supply voltage, which makes them suitable for base station or mobile operation.

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45% is specified for a power output of 70 W performance or IMD figures, typical distortion products

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LINEAR AMPLIFIERS FOR MOBILE OPERATION

INTRODUCTION

The three versions of the amplifier described here are intended mainly for amateur radio applications, but are suitable for other applications such as marine radio with slight modifications.

100 W is obtained with two MRF453's. (A similar device is available as HEP S3037.) MRF460 is also adaptable to this design, resulting in approximately 1.0 to 1.5 dB higher overall power gain than the values shown. The MRF454 devices which can be directly substituted with MRF465's for slightly lower IMD, deliver the 140 W, and two MRF421 devices are used in the 180 W version.

The use of chip capacitors results in good repeatability, making the overall design suitable for mass production.

There are several precautions and design hints to be taken into consideration regarding transistor amplifiers:

- Eliminate circuit oscillation. Oscillations may cause overdissipation of the device or exceed the breakdown voltages.
- 2. Limit the power supply current to prevent excessive dissipation.
- 3. Adopt protective circuitry, such as fast acting ALC.
- 4. Ensure proper attachment of the device to a heatsink using Silicone grease (such as Corning 340 or GC Electronics 8101) to fill all thermal gaps.

THE TRANSISTORS

The MRF421 with a specified power output of 100 W PEP or CW is the largest of the three RF devices. The maximum dissipation limit is 290 Watts, which means that the continuous collector current could go as high as 21.3 A at 13.6 V operated into any load. The data sheet specifies 20 A; this is actually limited by the current carrying capability of the internal bonding wires. The values given are valid at a 25° C mount temperature.

The minimum recommended collector idling current in Class AB is 150 mA. This can be exceeded at the expense of collector efficiency, or the device can be operated in Class A at an idling current of approximately one fourth the maximum specified collector current. This rule of thumb applies to most RF power transistors, although not specified for Class A operation. The MRF454 is specified for a power output of 70 W CW. Although the data sheet does not give broadband performance or IMD figures, typical distortion products are \approx -31 to -33 dB below one of the two test tones (7) with a 13.6 V supply. This device has the highest figure of merit (ratio of emitter periphery and base area), which correlates with the highest power gain.

The maximum dissipation is 180 Watts, and the maximum continuous collector current is 15 A. The minimum recommended collector idling current is 100 mA, and like the MRF421, can be operated in Class A.

The MRF453 has the lowest figure of merit, but due to the lower power specification, its gain exceeds that of the MRF421. This power gain is caused by the lower currents incorporated within the transistor package, and reduced circuit construction difficulties for low voltage operation.

At a power level of 180 Watts and 13.6 V, the peak currents approach 30 A, and every 100 mV lost in the emitter grounding or collector dc feed have a significant effect in the peak power capability. The minimum collector idling current for the MRF453 is recommended as 40 mA for Class AB, but can be operated at 3 A for Class A.

The MRF452 is specified for 50 Watts CW but typically makes -32 to -34 dB in reference to one of the two test tones at 50 Watts PEP, 13.6 Volts.

It should be noted that the data sheet figures for power gain and linearity are lowered when the device is used in multi-octave broadband circuit. Normally the device input and output impedances vary by at least a factor of three from 1.6 to 30 MHz. Therefore, when impedance correction networks are employed, some of the power gain and linearity must be sacrificed.

The input correction network can be designed with RC or RLC combinations to give better than 1 dB gain flatness across the band with low input VSWR. In a low-voltage system, little can be done about the output without reducing the maximum available voltage swing.

THE BASIC CIRCUIT

Figure 1 shows the basic circuit of the linear amplifier. For different power levels and devices, the impedance ratios of T1 and T3 will be different and the values of R1, R2, R3, R4, R5, C1, C2, C3, C4 and C6 will have to be changed.

Circuit diagrams external to Motorola products are included as a means of illustrating typical semiconductor applications; consequently, complete information sufficient for construction purposes is not necessarily given. The information in this Application Note has been carefully checked and is believed to be entirely reliable. However, no responsibility is assumed for inaccuracies. Furthermore, such information does not convey to the purchaser of the semiconductor devices described any license under the patent rights of Motorola Inc. or others.



FIGURE 1 - Basic Circuit of Linear Amplifier

The Bias Voltage Source

The bias voltage source uses active components (MC1723G and Q3) rather than the clamping diode system as seen in some designs. The advantages are line voltage regulation capability, low stand-by current, (\geq 1.0 mA) and wide range of voltage adjustability. With the component values shown, the bias voltage is adjustable from 0.5 to 0.9 Volts, which is sufficient from Class B to Class A operating conditions.

In Class B the bias voltage is equal to the transistor V_{BE} , and there is no collector idling current present (except small collector-emitter leakage, ICES), and the conduction angle is 180° .

In Class A the bias is adjusted for a collector idling current of approximately one-half of the peak current in actual operating conditions, and the conduction angle is 360° .

In Class AB, (common for SSB amplifiers) the bias is set for a low collector quiescent current, and the conduction angle is usually somewhat higher than 180° .

The required base bias current can be approximated as:

$$\frac{I_{C}}{h_{FE}}$$
,

where:

 I_C = Collector current, assuming an efficiency of 50%

and P_{out} of 180 W is: $\frac{2P_{out}}{V_{CC}} = \frac{360}{13.6} = 26.47$ A. hFE = Transistor dc beta (typical 30, from data sheet)

Bias current = $\frac{26.47}{30}$ = 0.88 A

R12 shares the dissipation with Q3, and its value must be such that the collector voltage never drops below

approximately 2.0 V (e.g. $\frac{(13.6-2)}{0.88} = 13.2 \Omega$). The

MRF421 devices used for this design had hFE values on the high side (45), and R12 was calculated as 20Ω , which is also sufficient for the lower power versions.

R5 determines the current limiting characteristics of the MC1723, and 0.5 Ω will set the limiting point to 1.35 A, ± 10%.

For SSB operation, excluding two-tone testing, the

the circuit board.

The measured output voltage variations of the bias source from zero to 1.0 A were \pm 8-12 mV resulting in a source impedance of \approx 30 m Ω .

The Input Frequency Correction Network

The input correction network consists of R1, R2, C2 and C3. With the combination of the negative feedback derived from L5 through R3 and R4 (Figure 1), it forms an attenuator with frequency selective characteristics. At 30 MHz the input power loss is 1-2 dB, increasing to 10-12 dB at 1.6 MHz. This compensates the gain variations of the RF transistors over the 1.6 to 30 MHz band, resulting in an overall gain flatness of approximately ± 1.0 to ± 1.5 dB.

Normally an input VSWR of 2.0:1 or lower (Figure 8) is possible with this type of input network (considered sufficient for most applications). More sophisticated



FIGURE 2 - Photograph of 180 W Version of the Linear Amplifier

duty cycle is low, and the energy charged in C11 can supply higher peak bias currents than required for 180 W PEP.

It is possible to operate the basic regulator circuit, MC1723, at lower output voltages than specified, with modified component values, at a cost of reduced line and output voltage regulation tolerances which are still more than adequate for this application. Temperature sensing diode D1 is added for bias tracking with the RF power transistors. The base-emitter junction of a 2N5190 or similar device can be used for this purpose. The temperature tracking within 15% to 60° C is achieved, even though the die processing is quite different from that of the RF transistors. The physical dimensions of Case 77 (2N5190) permits its use for the center stand-off of

LRC networks will yield slightly better VSWR figures, but are more complex and sometimes require individual adjustments.

Additional information on designing and optimizing these networks can be found in reference (2).

The Broadband Transformers

The input transformer T1 and the output transformer T3 are of the same basic type, with the low impedance winding consisting of two pieces of metal tubing, electrically shorted in one end and the opposite ends being the connections of this winding (Figure 3A). The multiturn high impedance winding is threaded through the tubing so that the low and high impedance winding connections are in opposite ends of the transformer.



The physical configuration can be implemented in various manners. A simplified design can be seen in Figure 3B. Here the metal tubing is substituted with copper braid, obtained from any co-axial cable of the proper diameter (4). The coupling coefficient between the primary and secondary windings is determined by the length-to-diameter ratio of the metal tubing or braid, and the gauge and insulation thickness of the wire used for the high impedance winding. For high impedance ratios (36:1 and higher), miniature co-axial cable where only the braid is used, leaving the inner conductor disconnected gives the best results. The high coefficient of coupling is important only at the high-frequency end of the band, e.g. 20 to 30 MHz. Additional information on these transformers can be found in reference (5).

Both transformers are loaded with ferrite material to provide sufficient low-frequency response. The minimum required inductance in the one turn winding can be calculated as:

$$L = \frac{R}{2\Pi f}$$

where

 $L = Inductance in \mu H$ R = Base-to-Base or Collector-to-Collector Impedance f = Lowest Frequency in MHz

For example, in the 180 Watt version the input transformer is of 16:1 impedance ratio, making the secondary impedance 3.13 Ω with a 50 Ω interface.

Then:
$$L = \frac{3.13}{6.28 \times 1.6} = 0.31 \ \mu H$$

For the output transformer having a 25:1 impedance ratio to a 50 Ω interface, L = $\frac{2}{6.28 \times 1.6}$ = 0.20 μ H.

It should be noted that in the lower power versions, where the input and output impedances are higher and the transformers have lower impedance ratios, the required minimum inductances are also higher.

T2, the collector choke supplying the dc to each collector, also provides an artificial center tap for T3. This combination functions as a real center tapped transformer with even harmonic cancellation. T2 provides a convenient low impedance source for the negative feedback voltage, which is derived from a separate one turn winding.

T3 alone does not have a true ac center tap, as there is virtually no magnetic coupling between its two halves. If the collector dc feed is done through point E (Figure 1) without T2, the IMD or power gain is not affected, but the even harmonic suppression may be reduced by as much as 10 dB at the lower frequencies.

The characteristic impedance of ac and bd (T2) should equal the collector-to-collector impedance but is not critical, and for physical convenience a bifilar winding is recommended.

The center tap of T2 is actually bc (Figure 1), but for stabilization purposes, b and c are separated by RF chokes by-passed individually by C8 and C9.

		100 W AMPLIFIER	140 W AMPLIFIER	180 W AMPLIFIER	
	C1	51 pF	51 pF	82 pF	
	C2 C3	5600 pF	5600 pF	6800 pF	
	C4	_	390 pF	1000 pF	
100.00	C5	680 pF	680 pF	680 pF	
	C6	1620 pF (2 x 470 pF	1760 pF (2 x 470 pF	1940 pF (2 x 470 pF	
1		chins + 680 pE dipped	chips + 820 pF dipped	chips + 1000 pE dipped	
1 40		mica in parallel)	mica in parallel)	mice in parallel)	
	C8 C9				
1.1	C10	100 µE/20 V	100 #F/20 V	100 µF/20 V	
1 12	010	electrolytic	electrolytic	electrolytic	
1	C11	500 // E/3 V	500 UE/2 V	500 ((E/2))	
	CII	electrolytic	slootrolutio		
	C12	1000 pE disc caramia	1000 pE dise coromic	1000 pE dise coromic	
	R1 R2	2 × 2 0 0/1/ W in parallel	2 × 2 6 Q/1/ W in possilial	2 x 2 2 Q/14 W in parallal	
	P2 P4	2 x 3.3 52/72 W in parallel	2×5.0 $32/2$ W in parallel	2 x 3.3 52/72 W Inparatiel	
	n3, n4 P5	1 0 0 /1/ W		2 x 3.9 52/72 vv inparatiel	
	no PC	1.0 56/72 00	0.5 36/ /2 00	0.5 \$67 72 W	
		1.0 K32/72 VV	1.0 K36/ /2 VV	1.0 K36/ /2 W	
	R/	18 K34/2 W	18 K34/2 W	18 KSL/ 1/2 W	
	Ro	8.2 KSL//2 VV	8.2 K32/ 1/2 W	8.2 K32/ /2 VV	
	R9	1.0 KS2 trimpot	1.0 ks2 trimpot	1.0 KM trimpot	
	R10	150 S2/½ W	150 32/½ W	150 \2/½ W	
1	RII	1.0 K32/ ½ W	1.0 K32/ ½ W	1.0 KS2/ 1/2 VV	
1.80	R12	20 32/5 W	2032/5 W	20 32/5 W	
	L1, L2	Ferroxcube VK200 19/4B territe choke			
	L3, L4	I wo Fair-Rite Products territe beads 2673021801 or equivalent on AWG #16 wire each.			
1	L5	1 separate turn through toro	old of 12.		
	11	9:1 (3:1 turns ratio)	9:1 (3:1 turns ratio)	1 16:1 (4:1 turns ratio)	
		Perrite core: Stackpole 5/-1845-248, Fair-Alte Products 28/3000201 or two Fair-Alte			
		Products 0.375 OD x 0.20	U ID X 0.400°, Material // be	ads for type A (Figure 3)	
	-	transformer. See text.			
	12	6 turns of AWG #18 enameled, bifflar Wire			
	-	Ferrite core: Stackpole 57-	9322, Indiana General F627-8 0	al or equivalent.	
1.	13	16:1 (4:1 turns ratio)	16:1 (4:1 turns ratio)	25:1 (5:1 turns ratio)	
		Pernite core: 2 Stackpole 57-3238 territe sleeves (7D material) or humber of toroids			
1.3%		with similar magnetic characteristics and 0.175" sq. total cross sectional area. See text.			
		All capacitors except C12, p	part of C5 and the electrolytics	are ceramic chips.	
also so		Values over 82 pF are Unior	n Carbide type 1225 or Varady	ne size 14.	
ister er		Others are type 1813 or size	18 respectively.	et Smoni triaur ani stati 'oc	
	01, 02	MRF453	/ MRF454	MRF421	
Non DC	0.3	- = 1 and main O Of a state	2N5989 or equivalent	disciple (4) The counting ou	
and the second second	D1 0.1 x 85	9	2N5190 or equivalent	and demonstrate of the state of	
	D2		Not Used	mary and secondary withinks is	
V 19WO		It should be noted that in	(Not used b	-to-diameter ratio of the metal	
and shi		Dotted line in performance	Dashed line in performance	Solid line in performance	
Testa -		data	data	data	
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1.2. the concetor choke supplying the dc to each offector, also provides an artificial center tap for T3 his combination functions as a real center tapped trans ormer with even harmonic cancellation. T2 provide

GENERAL DESIGN CONSIDERATIONS

As the primary and secondary windings of T3 are electrically isolated, the collector dc blocking capacitors (which may also function as low-frequency compensation elements) have been omitted. This decreases the loss in RF voltage between the collectors and the transformer primary, where every 100 mV amounts to approximately 2 W in output power at 180 W level. The RF currents at the collectors operating into a 2 Ω load are extremely high, e.g.: IRF = $\sqrt{\frac{180}{2.0}}$ = 9.5 A, or peak $\frac{9.5}{0.707}$ = 13.45 A.

Similarly, the resistive losses in the collector dc voltage path should be minimized. From the layout diagram of only the braid is used, leaving the inner conductor dis connected gives the best results. The high coefficien of coupling is important only at the high-frequency end of the band, e.g. 20 to 30 MHz. Additional informa

the lower side of the circuit board (Figure 4), VCC is brought through two 1/4" wide runs, one on each side of the board. With the standard 1.0 oz. laminate, the copper thickness is 1.4 thousands of an inch, and their combined cross sectional area would be equivalent to AWG #20 wire. This is not adequate to carry the dc collector current which under worst case conditions can be over 25 A. Therefore, the high power version of this design requires 2 oz. or heavier copper laminate, or these runs should be reinforced with parallel wires of sufficient gauge.

The thermal design (determining the size and type of a heat sink required) can be accomplished with information in the device data sheet and formulas presented in references 5 and 6. As an example, with the 180 W unit using MRF421's, the Junction-to-Ambient Temperature $(R_{\theta}JA)$ is calculated first as $R_{\theta}JA = \frac{TJ - TA}{P}$ where:

 $T_J =$ Maximum Allowed Junction Temperature (150°C). $T_A =$ Ambient Temperature (40°C).

P = Dissipated Power
$$(\frac{180}{\eta}) \times (100 - \eta)$$

 η = Collector Efficiency (%).

If the worst case efficiency at 180 W CW is 55%, then

P = 148 W, and
$$R_{\theta JA} = \frac{150 - 40}{(\frac{148}{2})} = 1.49^{\circ} \text{ C/W}$$
 (for one

Loops can be provided for current probe measurements.



device). The Heat Sink-to-Ambient Thermal Resistance, $R_{\theta SA} = R_{\theta JA} - (R_{\theta JC} + R_{\theta CS})$ where: $R_{\theta JC} = Device$ Junction-to-Case Thermal Resistance, 0.60°C/W* (from data sheet).

 $R_{\theta CS}$ = Thermal Resistance, Case-to-Heat Sink, 0.1°C/W (from table in reference 5).

Then:
$$R_{\theta SA} = \frac{1.49 - (0.60 + 0.1)}{2} = 0.395^{\circ} \text{ C/W}$$

This number can be used to select a suitable heat sink for the amplifier. The information is given by most manufacturers for their standard heat sinks, or specific lengths of extrusion. As an example, a 9.1" length of thermalloy 6153 or a 7.6" length of Aavid Engineering 60140 extrusion would be required for 100% duty cycle, unless the air velocity is increased by a fan or other means.



FIGURE 4 - Component Layout of the Basic Amplifier



FIGURE 5 – An Example of the IMD Spectral Display (c. Power Output = 180 W PEP, 30.00 MHz)

The Two Tones Have Been Adjusted 6 dB Below the Top Line, and the Distortion Products Relative to Peak Power can be Directly Read on the Scale.

PERFORMANCE AND MEASUREMENTS

The performance of each amplifier was measured with equipment similar to what is described in reference (2). The solid lines in Figures 6, 7, 8 and 9 represent the 100 W unit, the dashed lines represent the 140 W unit, and the dotted lines refer to the 180 W version. The data presented is typical, and spreads in the transistor hFE's will result in slight variations in RF power gain (Figure 7).

The performance data is also affected by the purity of the driving source. There should be at least 5-6 dB IMD margin to the expected power amplifier specification, and a harmonic suppression of 50 dB minimum below the fundamental is recommended (7).

The IMD measurements were done in accordance to the E.I.A. proposed standard, commonly employed in Ham Radio and other commercial equipment design. The distortion products are referenced to the peak power, and adjusting the tone peaks 6 dB below the 0 dB line on the spectrum analyzer screen (Figure 5) provides a direct reading on the scale.

The collector efficency under two tone test conditions is normally 15 - 20% lower than at CW. The load line has been optimized for the peak power (as well as possible in a broadband system with transformer impedance ratios of 4:1, 9:1, 16:1, 25:1, etc. available), which at SSB represents a smaller duty cycle, and the power output varies between zero and maximum. Typical figures are 40 - 45% and 55 - 65% respectively.

The stability and load mismatch susceptibility were tested at 15 and 30 MHz employing an LC network (2) to simulate high and low reactive loads at different phase angles. The maximum degree of load mismatch was controlled by placing high power 50-Ohm attenuators between the amplfiier output and variable LC network.



FIGURE 6 - Intermodulation Distortion versus Power Output



FIGURE 8 - Input VSWR and Collector Efficiency versus Frequency



A 2 dB attenuator limits the output VSWR to 4.5:1, 3 dB to 3.0:1, 6 dB to 1.8:1 etc., assuming that the simulator is capable of infinite VSWR at some phase angle. The attenuators for -1.0 dB or less were constructed of a length of RG-58A co-axial cable, which at 30 MHz has an attenuation of 3.0 dB/100 ft. and at 15 MHz 2.0 dB/100 ft. Combinations of the cable and the resistive attenuators can be used to give various degrees of total attenuation.

The tests indicated the 100 W and 140 W amplifiers to be stable to 5:1 output VSWR at all phase angles, and the 180 W unit is stable to 9:1. All units passed a load mismatch test at full rated CW power at an output load mismatch of 30:1, which they were subjected to, until the heat sink temperature reached 60° C. For this, the load mismatch simulator was motor driven with a 2 second cycle period.

Output Filtering

Depending on the application, harmonic suppression of -40 dB to -60 dB may be required. This is best accomplished with low-pass filters, which (to cover the entire range) should have cutoff frequencies (e.g. 35 MHz, 25 MHz, 15 MHz, 10 MHz, 5.5 MHz and 2.5 MHz).

The theoretical aspect of low-pass filter design is well covered in the literature (8).

A simple Chebyshev type constant K, 2 pole filter (Figure 10) is sufficient for 40 - 45 dB output harmonic suppression.



FIGURE 10

The filter is actually a dual pi-network, with each pole introducing a -90° phase shift at the cutoff frequency, where L1, L2, C1 and C3 should have a reactance of

50 Ohms, and C2 should be 25 Ohms. If C2 is shorted, the resonances of L1C1 and L2C3 can be checked with a grid-dip meter or similar instrument for their resonant frequencies.

The calculated attenuation for this filter is 6.0 dB per element/octave, or -45 dB for the 3rd harmonic. In practice, only -35 to -40 dB was measured, but this was due to the low Q values of the inductors (approximately 50). Air core inductors give excellent results, but toroids of magnetic materials such as Micrometals grade 6 are also suitable at frequencies below 10 MHz. Dipped mica capacitors can be used throughout.

If the filters are correctly designed and the component tolerances are 5% or better, the power loss will be less than 1.0 dB.

SUMMARY

The basic circuit layout (Figure 1) has been successfully adopted by several equipment manufacturers. Minor modifications may be necessary depending on the availability of specific components. For instance, the ceramic chip capacitors may vary in physical size between various brands, and recent experiments show that values > 0.001 μ F can be substituted with unencapsulated polycarbonate stacked-foil capacitors. These capacitors are available from Siemens Corporation (type B32540) and other sources. Also T1 and T2 can be constructed from stacks of ferrite toroids with similar material characteristics. Toroids are normally stock items, and are available from most ferrite suppliers.

The above is primarily intended to give an example of the device performance in non-laboratory conditions, thus eliminating the adjustments from unit to unit.

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